

PowerMOS transistor

BUK465-100A

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic envelope suitable for surface mount applications.

The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in general purpose switching applications.

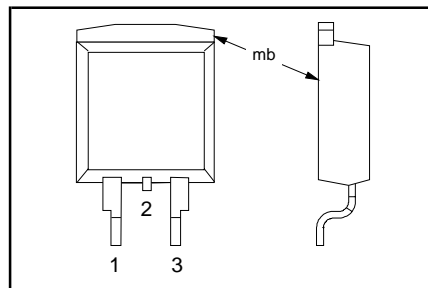
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | UNIT |
|--------------|----------------------------------|------|------|
| V_{DS} | Drain-source voltage | 100 | V |
| I_D | Drain current (DC) | 26 | A |
| P_{tot} | Total power dissipation | 125 | W |
| T_j | Junction temperature | 175 | °C |
| $R_{DS(ON)}$ | Drain-source on-state resistance | 0.08 | Ω |

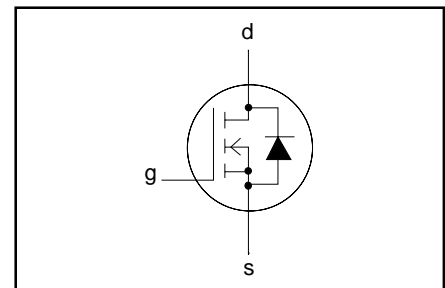
PINNING - SOT404

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | gate |
| 2 | drain |
| 3 | source |
| mb | drain |

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------|----------------------------------|--------------------------------------|------|------|------|
| V_{DS} | Drain-source voltage | - | - | 100 | V |
| V_{DGR} | Drain-gate voltage | $R_{GS} = 20\text{ k}\Omega$ | - | 100 | V |
| $\pm V_{GS}$ | Gate-source voltage | - | - | 30 | V |
| I_D | Drain current (DC) | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 26 | A |
| I_D | Drain current (DC) | $T_{mb} = 100\text{ }^\circ\text{C}$ | - | 18 | A |
| I_{DM} | Drain current (pulse peak value) | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 104 | A |
| P_{tot} | Total power dissipation | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 125 | W |
| T_{stg} | Storage temperature | - | - 55 | 175 | °C |
| T_j | Junction temperature | - | - | 175 | °C |

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|--|---|------|------|------|------|
| $R_{th\text{-j-mb}}$ | Thermal resistance junction to mounting base | | - | - | 1.2 | K/W |
| $R_{th\text{-j-a}}$ | Thermal resistance junction to ambient | minimum footprint FR4 board (see Fig 18). | - | 50 | - | K/W |

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STATIC CHARACTERISTICS $T_{mb} = 25\text{ °C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|----------------------------------|---|------|------|------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0\text{ V}; I_D = 0.25\text{ mA}$ | 100 | - | - | V |
| $V_{GS(TO)}$ | Gate threshold voltage | $V_{DS} = V_{GS}; I_D = 1\text{ mA}$ | 2.1 | 3.0 | 4.0 | V |
| I_{DSS} | Zero gate voltage drain current | $V_{DS} = 100\text{ V}; V_{GS} = 0\text{ V}; T_j = 25\text{ °C}$ | - | 1 | 10 | μA |
| I_{DSS} | Zero gate voltage drain current | $V_{DS} = 100\text{ V}; V_{GS} = 0\text{ V}; T_j = 125\text{ °C}$ | - | 0.1 | 1.0 | mA |
| I_{GSS} | Gate source leakage current | $V_{GS} = \pm 30\text{ V}; V_{DS} = 0\text{ V}$ | - | 10 | 100 | nA |
| $R_{DS(ON)}$ | Drain-source on-state resistance | $V_{GS} = 10\text{ V}; I_D = 13\text{ A}$ | - | 0.07 | 0.08 | Ω |

DYNAMIC CHARACTERISTICS $T_{mb} = 25\text{ °C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------|----------------------------|---|------|------|------|------|
| g_{fs} | Forward transconductance | $V_{DS} = 25\text{ V}; I_D = 13\text{ A}$ | 7.0 | 13.5 | - | S |
| C_{iss} | Input capacitance | $V_{GS} = 0\text{ V}; V_{DS} = 25\text{ V}; f = 1\text{ MHz}$ | - | 1650 | 2000 | pF |
| C_{oss} | Output capacitance | | - | 350 | 500 | pF |
| C_{rss} | Feedback capacitance | | - | 100 | 150 | pF |
| t_{don} | Turn-on delay time | $V_{DD} = 30\text{ V}; I_D = 3\text{ A};$ $V_{GS} = 10\text{ V}; R_{GS} = 50\text{ }\Omega;$ $R_{gen} = 50\text{ }\Omega$ | - | 15 | 30 | ns |
| t_r | Turn-on rise time | | - | 25 | 40 | ns |
| t_{doff} | Turn-off delay time | | - | 100 | 160 | ns |
| t_f | Turn-off fall time | | - | 50 | 80 | ns |
| L_d | Internal drain inductance | Measured from upper edge of drain tab to centre of die | - | 2.5 | - | nH |
| L_s | Internal source inductance | Measured from source lead soldering point to source bond pad | - | 7.5 | - | nH |

REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS $T_{mb} = 25\text{ °C}$ unless otherwise specified

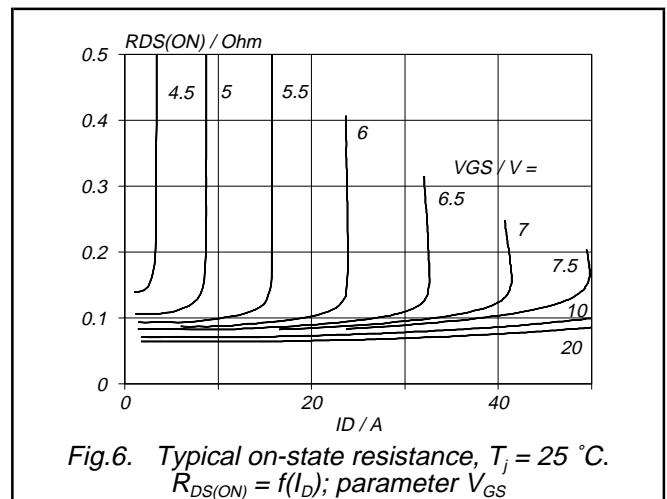
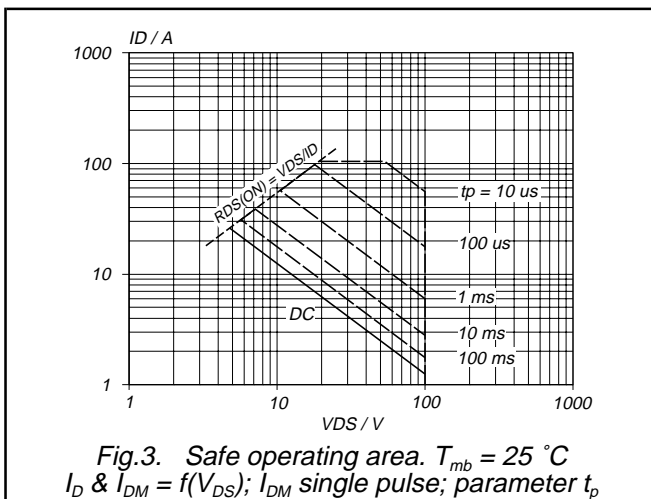
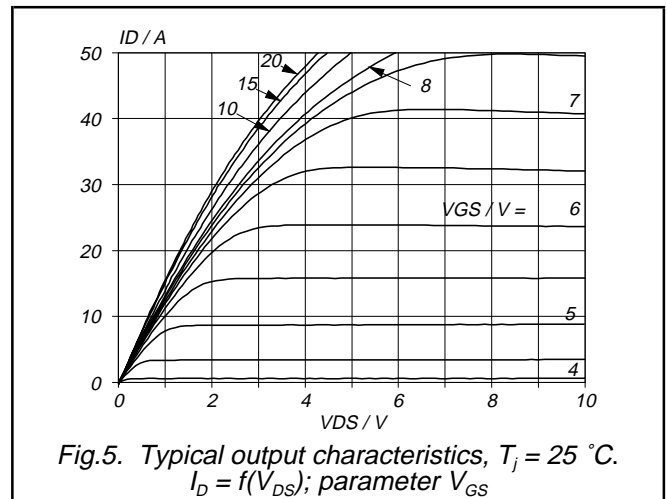
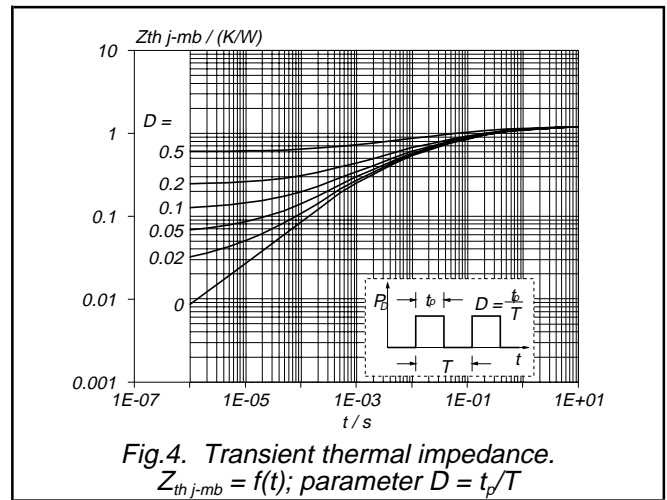
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|----------------------------------|---|------|------|------|---------------|
| I_{DR} | Continuous reverse drain current | - | - | - | 26 | A |
| I_{DRM} | Pulsed reverse drain current | - | - | - | 104 | A |
| V_{SD} | Diode forward voltage | $I_F = 26\text{ A}; V_{GS} = 0\text{ V}$ | - | 1.3 | 1.7 | V |
| t_{rr} | Reverse recovery time | $I_F = 26\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$ $V_{GS} = 0\text{ V}; V_R = 30\text{ V}$ | - | 90 | - | ns |
| Q_{rr} | Reverse recovery charge | | - | 0.8 | - | μC |

AVALANCHE LIMITING VALUE $T_{mb} = 25\text{ °C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|---|--|------|------|------|------|
| W_{DSS} | Drain-source non-repetitive unclamped inductive turn-off energy | $I_D = 26\text{ A}; V_{DD} \leq 50\text{ V};$ $V_{GS} = 10\text{ V}; R_{GS} = 50\text{ }\Omega$ | - | - | 100 | mJ |

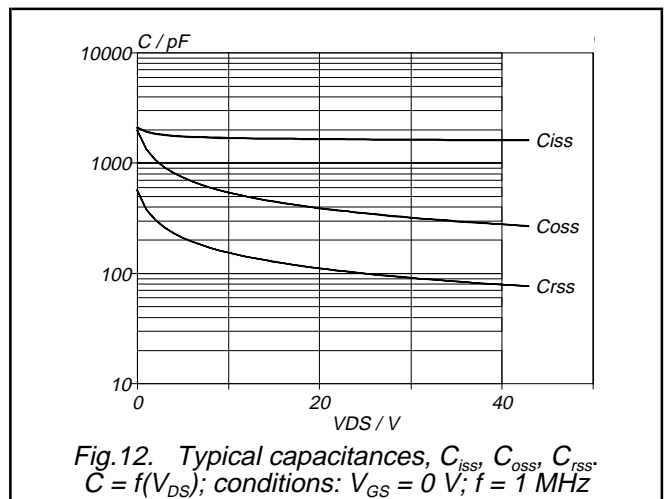
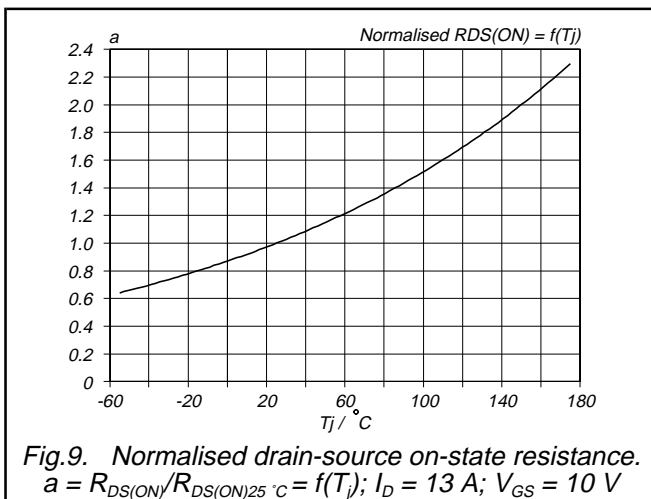
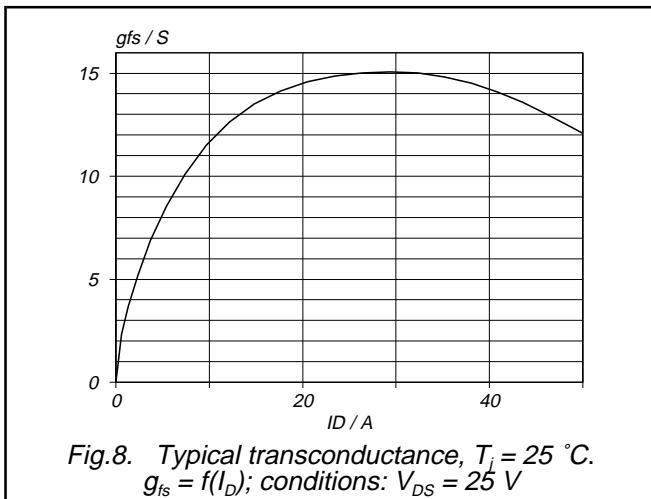
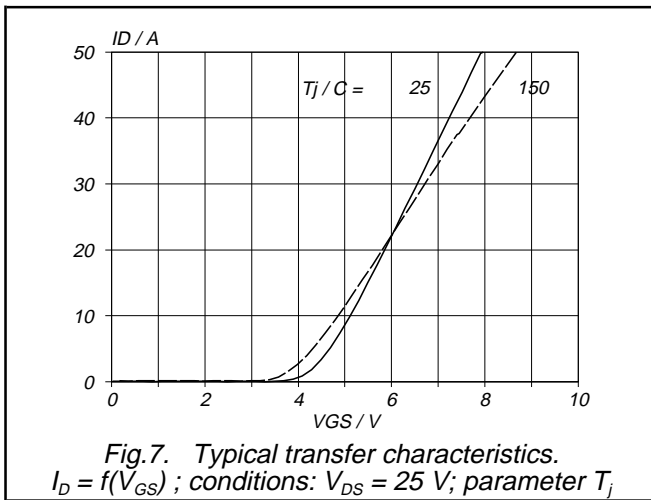
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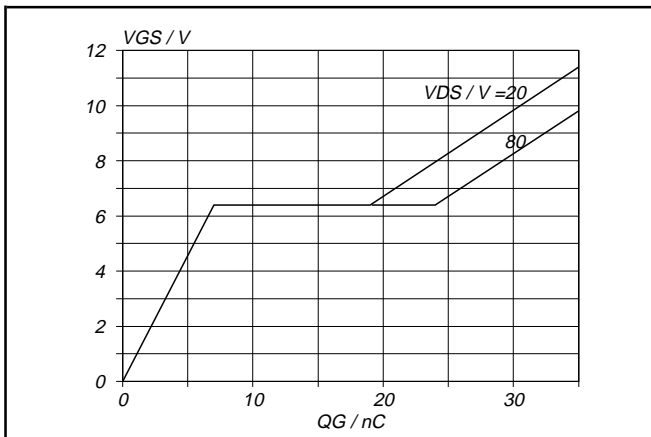


Fig. 13. Typical turn-on gate-charge characteristics. $V_{GS} = f(Q_G)$; conditions: $I_D = 26$ A; parameter V_{DS}

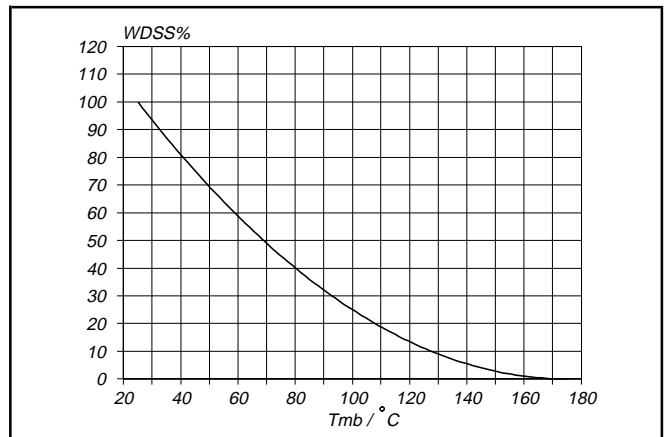


Fig. 15. Normalised avalanche energy rating. $W_{DSS}\% = f(T_{mb})$; conditions: $I_D = 26$ A

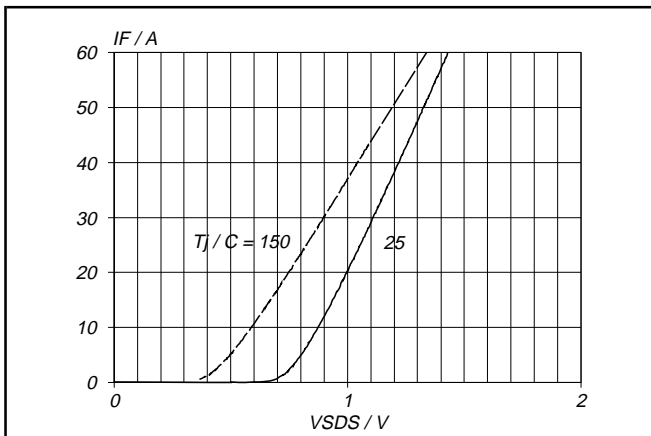


Fig. 14. Typical reverse diode current. $I_F = f(V_{SDS})$; conditions: $V_{GS} = 0$ V; parameter T_j

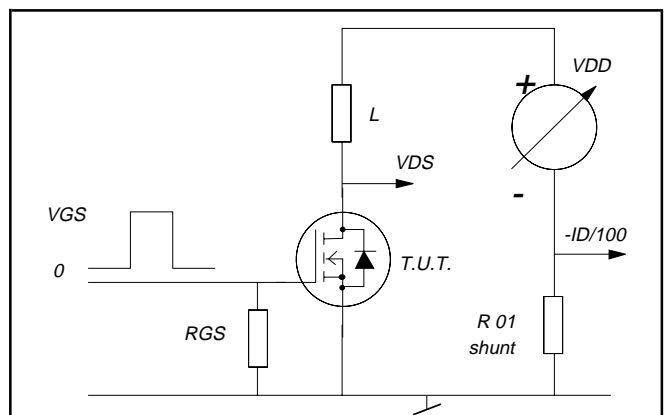


Fig. 16. Avalanche energy test circuit. $W_{DSS} = 0.5 \cdot L I_D^2 \cdot BV_{DSS} / (BV_{DSS} - V_{DD})$

MECHANICAL DATA

Dimensions in mm

Net Mass: 1.4 g

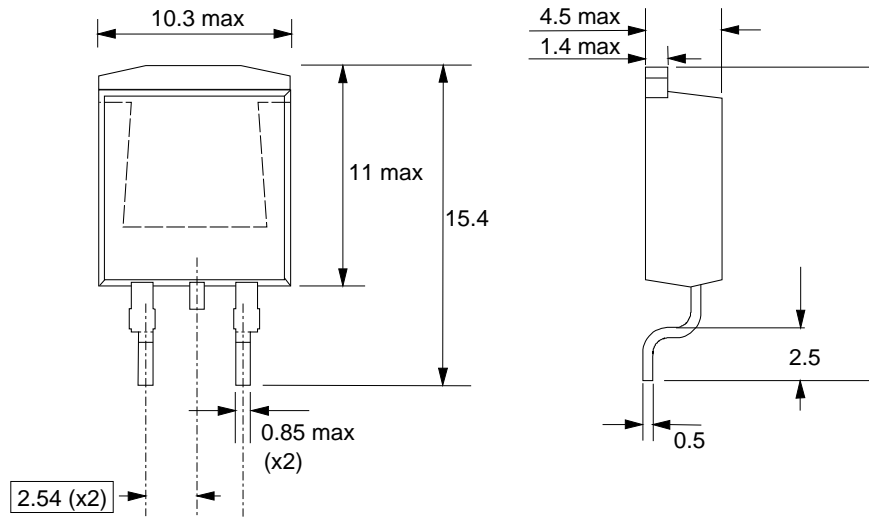


Fig.17. SOT404 : centre pin connected to mounting base.

MOUNTING INSTRUCTIONS

Dimensions in mm



Fig.18. SOT404 : soldering pattern for surface mounting.

Notes

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

| | |
|--|---|
| Data sheet status | |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |
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